



<i>flowPIM E2</i>	600 V / 50 A
<div style="border: 1px solid black; padding: 5px; margin-bottom: 10px;"> <p style="text-align: center; background-color: #ccc; margin: 0;">Features</p> <ul style="list-style-type: none"> Trenchstop™ IGBT3 technology Standard industrial housing Optimized $R_{th(j-s)}$ with Phase Change Material Built-in NTC </div> <div style="border: 1px solid black; padding: 5px; margin-bottom: 10px;"> <p style="text-align: center; background-color: #ccc; margin: 0;">Target applications</p> <ul style="list-style-type: none"> Industrial Drives </div> <div style="border: 1px solid black; padding: 5px;"> <p style="text-align: center; background-color: #ccc; margin: 0;">Types</p> <ul style="list-style-type: none"> 10-EY06PMA050SA-L184A38T 10-E206PMA050SA-L184A38Z </div>	<div style="border: 1px solid black; padding: 5px; margin-bottom: 10px;"> <p style="text-align: center; background-color: #ccc; margin: 0;"><i>flow E2 12 mm housing</i></p> <div style="display: flex; justify-content: space-around; align-items: center;"> </div> <div style="display: flex; justify-content: space-around; margin-top: 5px;"> Press-fit pin Solder pin </div> </div> <div style="border: 1px solid black; padding: 5px;"> <p style="text-align: center; background-color: #ccc; margin: 0;">Schematic</p> </div>

Maximum Ratings

$T_j = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
Inverter Switch				
Collector-emitter voltage	V_{CES}		600	V
Collector current	I_C	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	51	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	150	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	95	W
Gate-emitter voltage	V_{GES}		±20	V
Short circuit ratings	t_{SC}	$V_{GE} = 15\text{ V}$ $V_{CE} = 360\text{ V}$ $T_j = 150\text{ °C}$	6	µs
Maximum junction temperature	T_{jmax}		175	°C



Maximum Ratings

$T_j = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
Inverter Diode				
Peak repetitive reverse voltage	V_{RRM}		600	V
Continuous (direct) forward current	I_F	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	46	A
Repetitive peak forward current	I_{FRM}		100	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	67	W
Maximum junction temperature	T_{jmax}		175	°C
Brake Switch				
Collector-emitter voltage	V_{CES}		600	V
Collector current	I_C	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	51	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	150	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	95	W
Gate-emitter voltage	V_{GES}		±20	V
Short circuit ratings	t_{SC}	$V_{GE} = 15\text{ V}$ $V_{CE} = 360\text{ V}$ $T_j = 150\text{ °C}$	6	µs
Maximum junction temperature	T_{jmax}		175	°C
Brake Diode				
Peak repetitive reverse voltage	V_{RRM}		600	V
Continuous (direct) forward current	I_F	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	28	A
Repetitive peak forward current	I_{FRM}		40	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	50	W
Maximum junction temperature	T_{jmax}		175	°C
Rectifier Diode				
Peak repetitive reverse voltage	V_{RRM}		1600	V
Continuous (direct) forward current	I_F	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	51	A
Surge (non-repetitive) forward current	I_{FSM}	50 Hz Single Half Sine Wave $t_p = 10\text{ ms}$ $T_j = 150\text{ °C}$	350	A
Surge current capability	I^2t		610	A ² s
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	60	W
Maximum junction temperature	T_{jmax}		150	°C



Maximum Ratings

$T_j = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
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Module Properties

General Properties

Stray inductance	L_p		30	nH
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Thermal Properties

Storage temperature	T_{stg}		-40...+125	°C
Operation temperature under switching condition	T_{top}		-40...(T _{max} - 25)	°C

Isolation Properties

Isolation voltage	V_{isol}	DC Test Voltage* $t_p = 2\text{ s}$	6000	V
		AC Voltage $t_p = 1\text{ min}$	2500	V
Creepage distance			min. 12,7	mm
Clearance		Solder pin / Press-fit pin	8,85 / 8,83	mm
Comparative Tracking Index	CTI		≥ 600	

*100 % tested in production



Characteristic Values

Parameter	Symbol	Conditions					Value			Unit
		V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max		

Inverter Switch

Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{GE} = V_{CE}$			0,0008	25	5	5,8	6,5	V
Collector-emitter saturation voltage	V_{CEsat}		15		50	25 125 150	1,05	1,57 1,76 1,80	1,85	V
Collector-emitter cut-off current	I_{CES}		0	600		25			2,6	μA
Gate-emitter leakage current	I_{GES}		20	0		25			600	nA
Internal gate resistance	r_g							none		Ω
Input capacitance	C_{ies}							3140		pF
Output capacitance	C_{oes}	$f = 1$ Mhz	0	25		25		200		
Reverse transfer capacitance	C_{res}							93		

Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,00		K/W
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Dynamic

Turn-on delay time	$t_{d(on)}$	$R_{gon} = 8$ Ω $R_{goff} = 8$ Ω	±15	300	50	25		95		ns
Rise time	t_r					150		100		
Turn-off delay time	$t_{d(off)}$					25		14		
Fall time	t_f					150		18		
						25		161		
Turn-on energy (per pulse)*	E_{on}	$Q_{FWD} = 2,3$ μC $Q_{FWD} = 4,4$ μC				25		0,675		mWs
Turn-off energy (per pulse)*	E_{off}					150		1,02		
						25		1,30		
						150		1,76		

* $L_s = 10$ nH



Characteristic Values

Parameter	Symbol	Conditions					Value			Unit
		V_{GE} [V]	V_{CE} [V]	I_C [A]	T_j [°C]	Min	Typ	Max		

Inverter Diode

Static

Parameter	Symbol	V_{GE} [V]	V_{CE} [V]	I_C [A]	T_j [°C]	Min	Typ	Max	Unit
Forward voltage	V_F			50	25 125 150		1,64 1,56 1,54	1,9	V
Reverse leakage current	I_R		600		25			27	μA

Thermal

Parameter	Symbol	Conditions	Value	Unit
Thermal resistance junction to sink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)	1,41	K/W

Dynamic

Parameter	Symbol	dI/dt	V_{CE}	I_C	T_j	Min	Typ	Max	Unit
Peak recovery current	I_{RRM}	$dI/dt = 3939$ A/μs $dI/dt = 3496$ A/μs	±15	300	50	25	52		A
Reverse recovery time	t_{rr}					150	62		
						25	130		
Recovered charge	Q_r					150	172		
						25	2,29		
Reverse recovered energy	E_{rec}	150	4,37						
		25	0,515						
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$	150	0,92						
		25	3909						
			2375						



Characteristic Values

Parameter	Symbol	Conditions					Value			Unit
		V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max		

Brake Switch

Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{GE} = V_{CE}$			0,0008	25	5	5,8	6,5	V
Collector-emitter saturation voltage	V_{CEsat}		15		50	25 125 150	1,05	1,57 1,76 1,80	1,85	V
Collector-emitter cut-off current	I_{CES}		0	600		25			2,6	µA
Gate-emitter leakage current	I_{GES}		20	0		25			600	nA
Internal gate resistance	r_g							none		Ω
Input capacitance	C_{ies}							3140		pF
Output capacitance	C_{oes}	$f = 1$ Mhz	0	25		25		200		
Reverse transfer capacitance	C_{res}							93		

Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,00		K/W
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Dynamic

Turn-on delay time	$t_{d(on)}$					25 125 150		48 39 41		ns
Rise time	t_r	$R_{gon} = 16$ Ω $R_{goff} = 16$ Ω				25 125 150		44 47 48		
Turn-off delay time	$t_{d(off)}$		0 / 15	400	50	25 125 150		513 547 550		
Fall time	t_f					25 125 150		22 31 33		
Turn-on energy (per pulse)	E_{on}	$Q_{FWD} = 1,3$ µC $Q_{FWD} = 2,3$ µC $Q_{FWD} = 2,7$ µC				25 125 150		2,80 3,31 3,38		mWs
Turn-off energy (per pulse)	E_{off}					25 125 150		1,89 2,36 2,47		



Vincotech

10-EY06PMA050SA-L184A38T
10-E206PMA050SA-L184A38Z
 datasheet

Characteristic Values

Parameter	Symbol	Conditions					Value			Unit
		V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max		

Brake Diode

Static

Forward voltage	V_F				20	25 125		1,70 1,58	1,95	V
Reverse leakage current	I_R			600		25			27	µA

Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,91		K/W
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Dynamic

Peak recovery current	I_{RRM}					25 125 150		9 12 12		A
Reverse recovery time	t_{rr}					25 125 150		291 360 401		ns
Recovered charge	Q_r	$di/dt = 826$ A/µs $di/dt = 812$ A/µs $di/dt = 783$ A/µs	0 / 15	400	50	25 125 150		1,26 2,28 2,67		µC
Reverse recovered energy	E_{rec}					25 125 150		0,275 0,498 0,611		mWs
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					25 125 150		520 17 27		A/µs

Rectifier Diode

Static

Forward voltage	V_F				45	25 125		1,15 1,12		V
Reverse leakage current	I_R			1600		25			50	µA

Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,17		K/W
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Thermistor

Rated resistance	R					25		5		kΩ
Deviation of R_{100}	$\Delta_{R/R}$	$R_{100} = 493$ Ω				100	-5		+5	%
Power dissipation	P					25		245		mW
Power dissipation constant						25		1,4		mW/K
B-value	$B_{(25/50)}$	Tol. ±2 %				25		3375		K
B-value	$B_{(25/100)}$	Tol. ±2 %				25		3437		K
Vincotech NTC Reference										K



Inverter Switch Characteristics

figure 1. IGBT

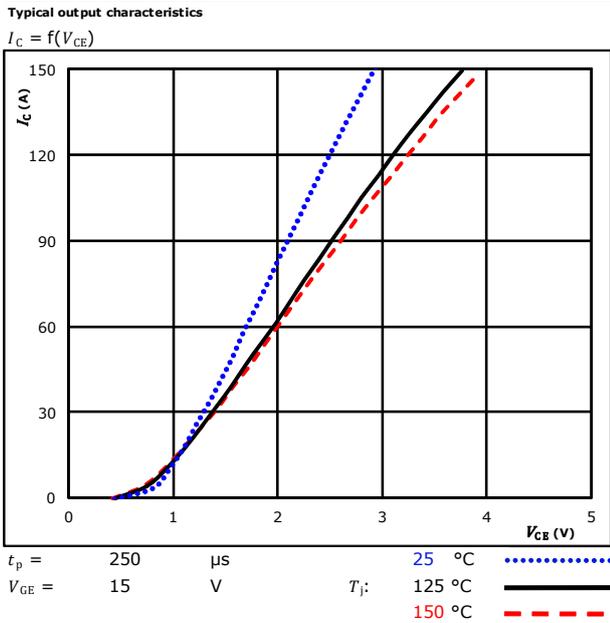


figure 2. IGBT

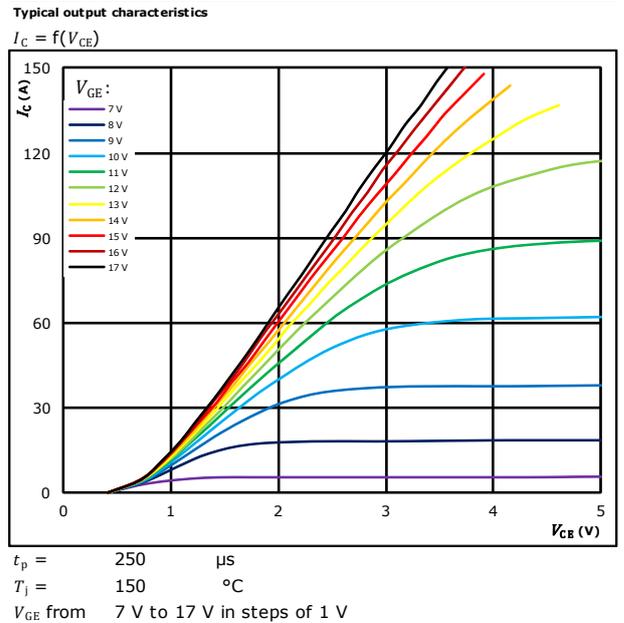


figure 3. IGBT

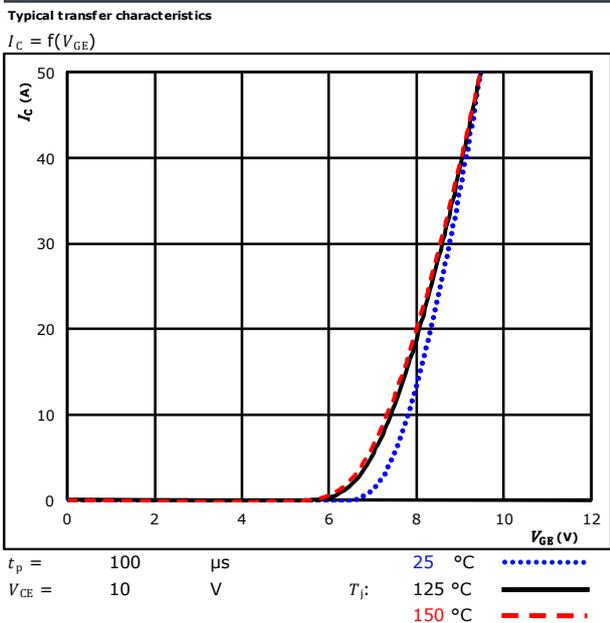
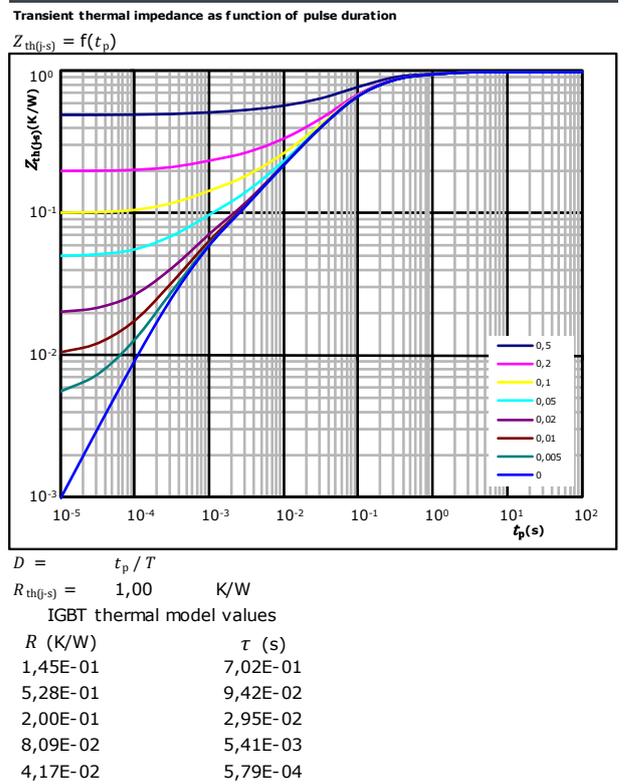


figure 4. IGBT





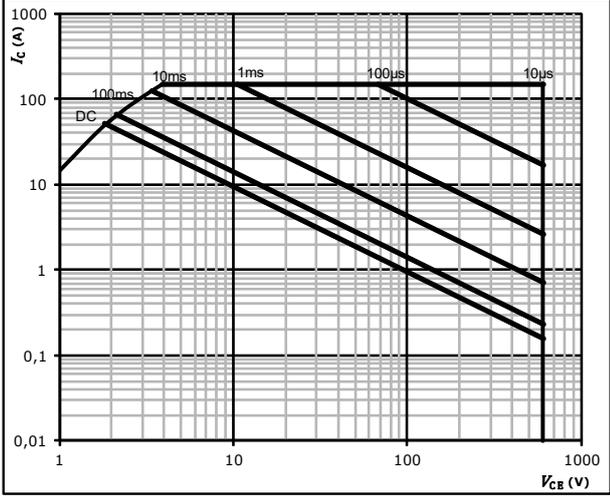
Vincotech

Inverter Switch Characteristics

figure 5. IGBT

Safe operating area

$$I_C = f(V_{CE})$$



- $D =$ single pulse
- $T_s = 80$ °C
- $V_{GE} = \pm 15$ V
- $T_j = T_{max}$

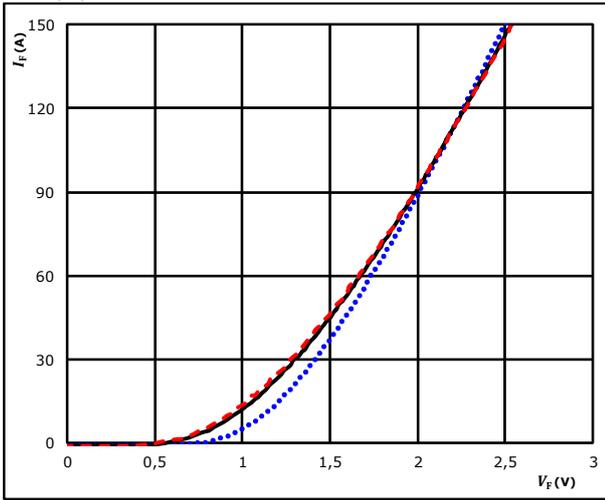


Inverter Diode Characteristics

figure 1. FWD

Typical forward characteristics

$$I_F = f(V_F)$$

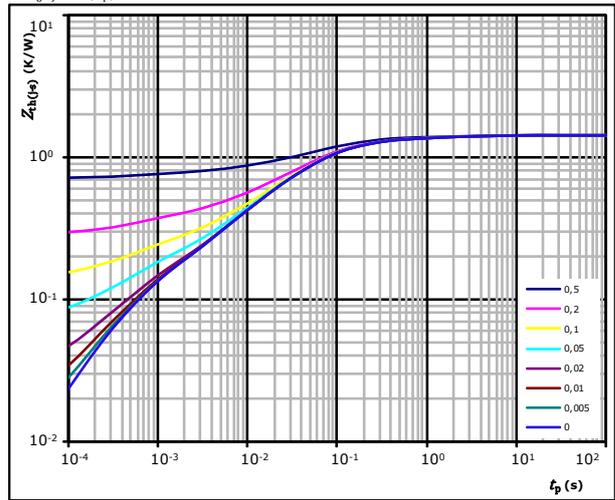


$t_p = 250 \mu s$
 T_j : 25 °C
 125 °C ———
 150 °C - - - -

figure 2. FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$
 $R_{th(j-s)} = 1,41 \text{ K/W}$

FWD thermal model values

R (K/W)	τ (s)
7,38E-02	2,82E+00
1,47E-01	4,00E-01
6,53E-01	7,18E-02
3,22E-01	2,02E-02
1,24E-01	4,33E-03
9,40E-02	4,82E-04



Brake Switch Characteristics

figure 1. IGBT

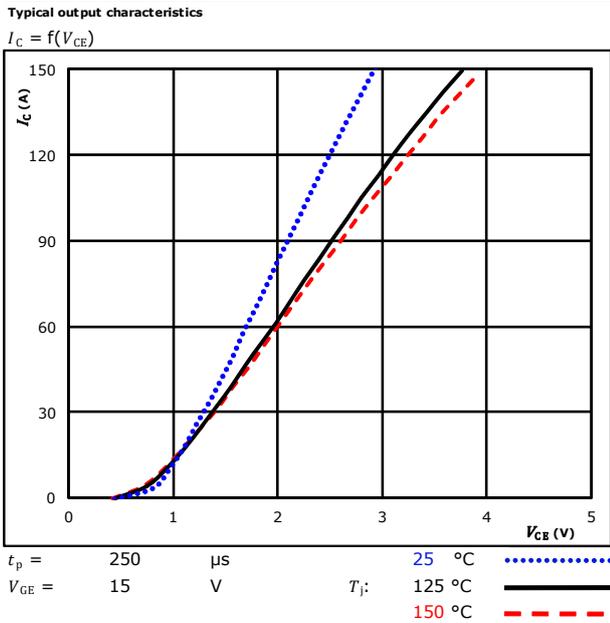


figure 2. IGBT

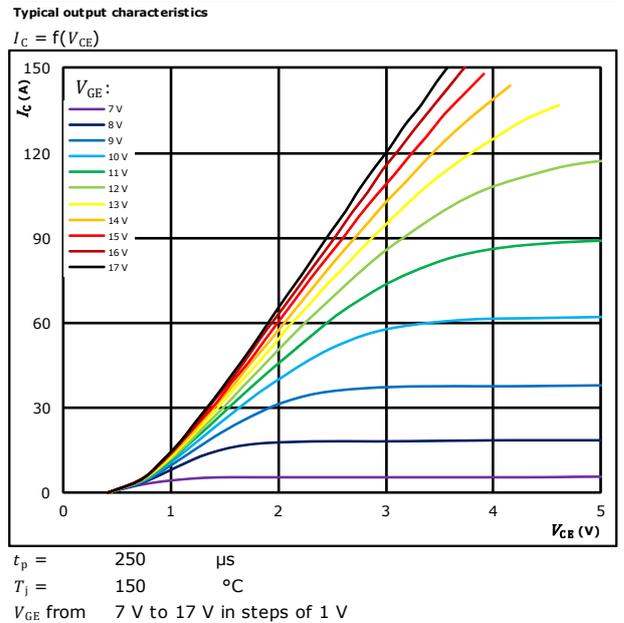


figure 3. IGBT

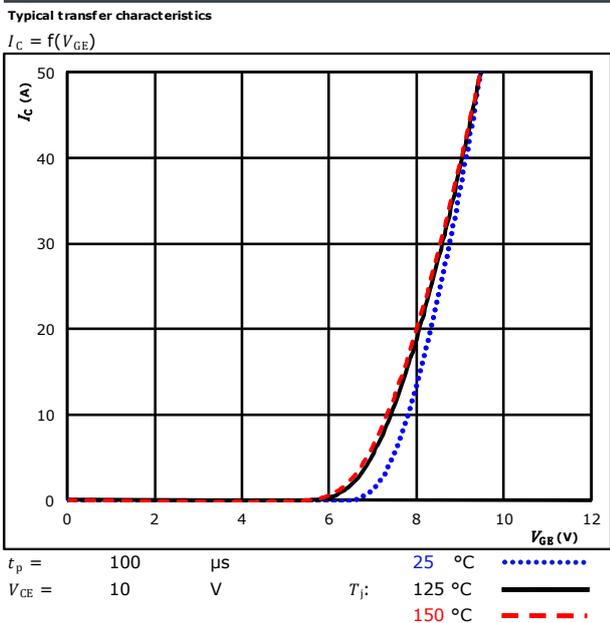
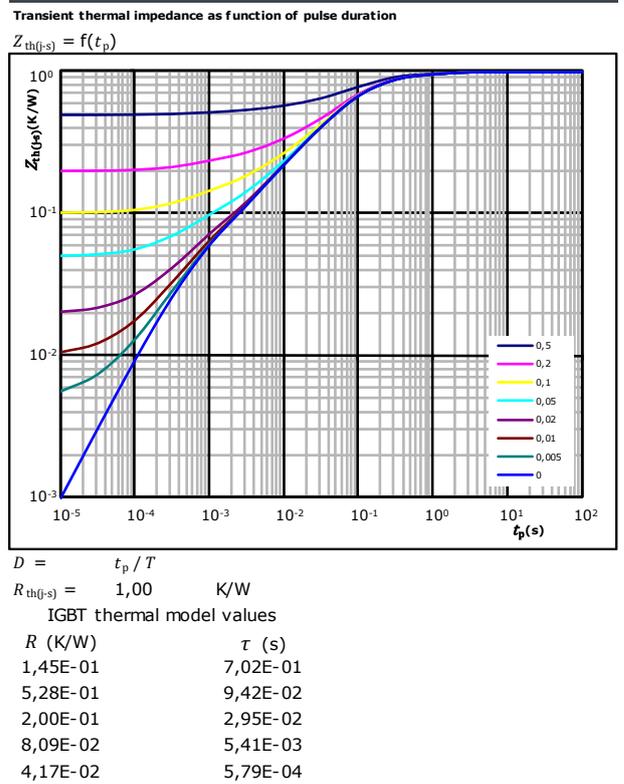


figure 4. IGBT



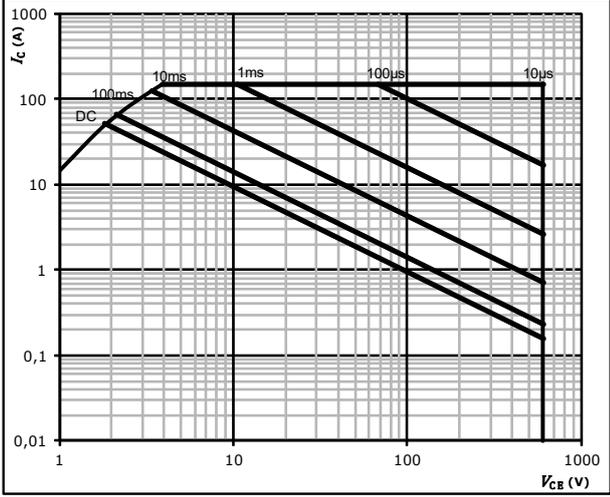


Brake Switch Characteristics

figure 5. IGBT

Safe operating area

$I_C = f(V_{CE})$



- $D =$ single pulse
- $T_s = 80$ °C
- $V_{GE} = \pm 15$ V
- $T_j = T_{max}$

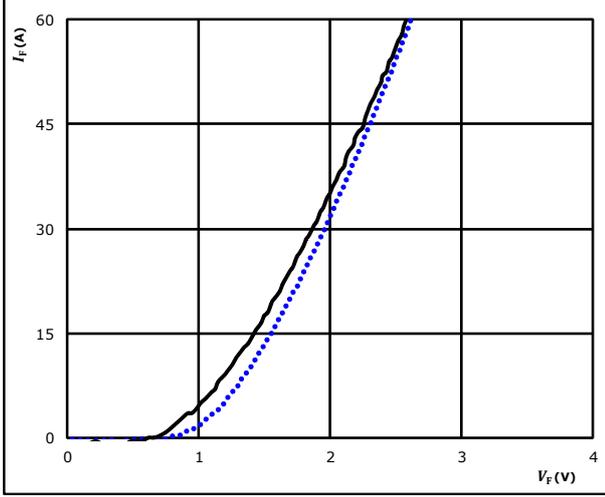


Brake Diode Characteristics

figure 1. FWD

Typical forward characteristics

$$I_F = f(V_F)$$

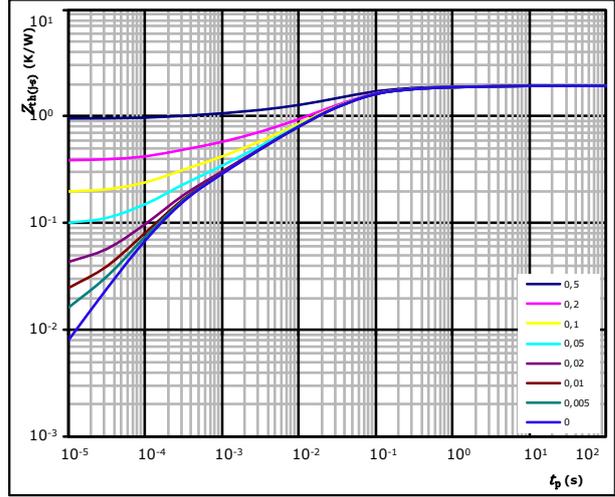


$t_p = 250 \mu s$ $T_j: 25 \text{ }^\circ\text{C}$ (blue dotted line) $125 \text{ }^\circ\text{C}$ (black solid line)

figure 2. FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$
 $R_{th(j-s)} = 1,91 \text{ K/W}$

FWD thermal model values

R (K/W)	τ (s)
8,07E-02	2,12E+00
2,18E-01	2,13E-01
8,50E-01	4,23E-02
4,32E-01	8,96E-03
2,00E-01	1,53E-03
1,34E-01	2,03E-04

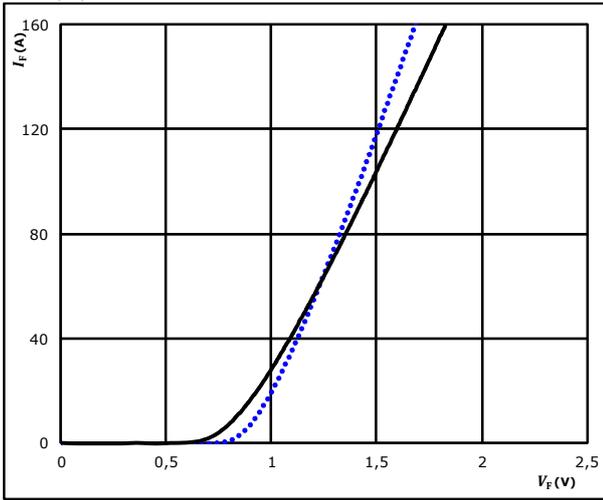


Rectifier Diode Characteristics

figure 1. Rectifier Diode

Typical forward characteristics

$$I_F = f(V_F)$$

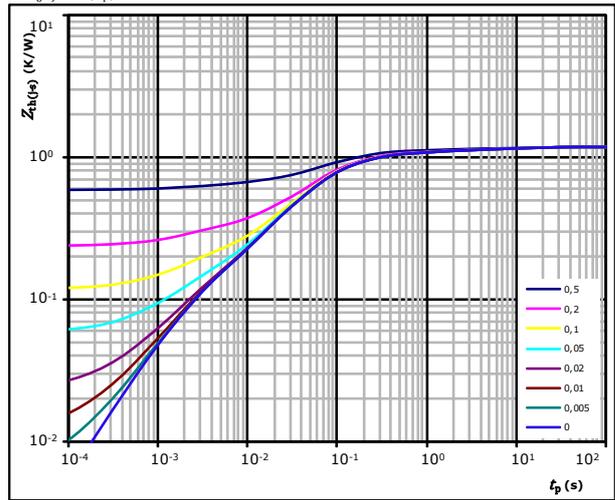


$t_p = 250 \mu s$ $T_j: 25 \text{ }^\circ\text{C}$ (dotted blue line) $125 \text{ }^\circ\text{C}$ (solid black line)

figure 2. Rectifier Diode

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$
 $R_{th(j-s)} = 1,17 \text{ K/W}$
 Diode thermal model values

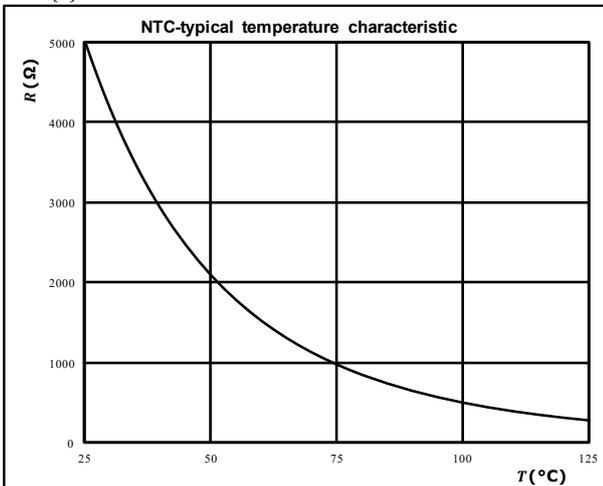
$R \text{ (K/W)}$	$\tau \text{ (s)}$
7,71E-02	9,00E+00
1,19E-01	7,09E-01
4,99E-01	1,03E-01
3,97E-01	3,61E-02
8,19E-02	2,07E-03

Thermistor Characteristics

figure 1. Thermistor

Typical NTC characteristic as a function of temperature

$$R = f(T)$$





Inverter Switching Characteristics

figure 1. IGBT

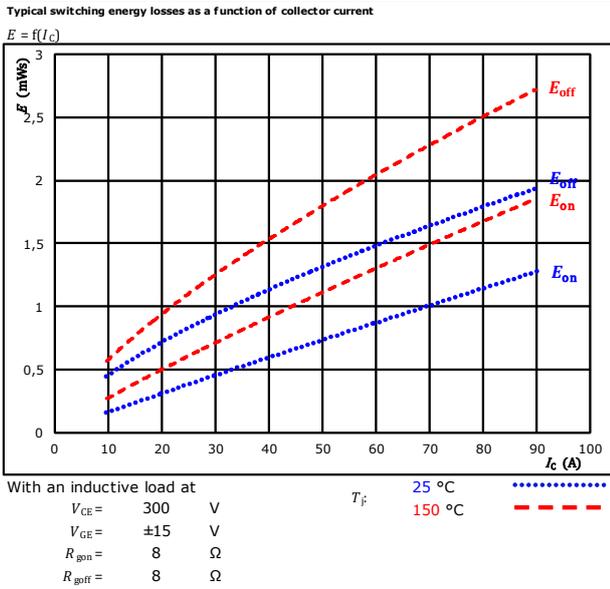


figure 2. IGBT

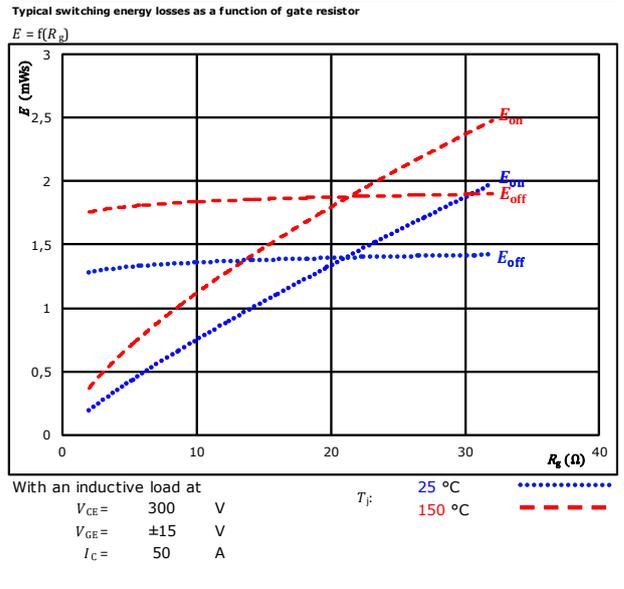


figure 3. FWD

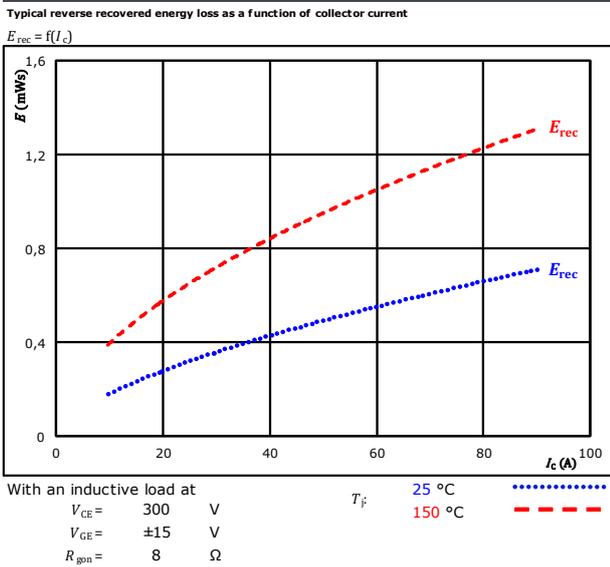
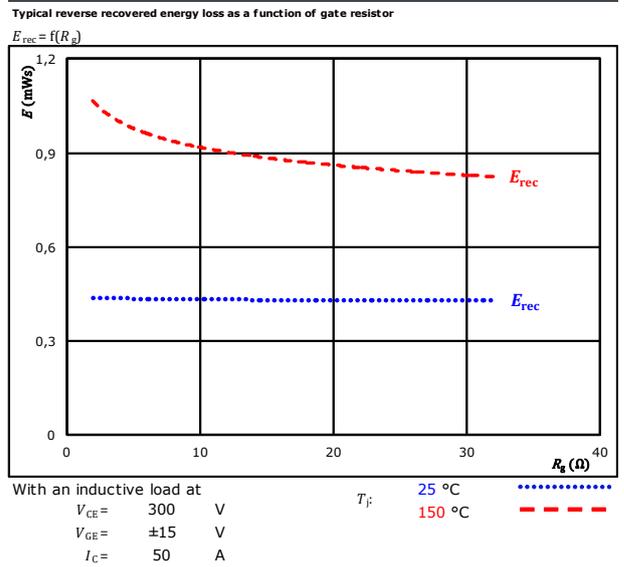


figure 4. FWD



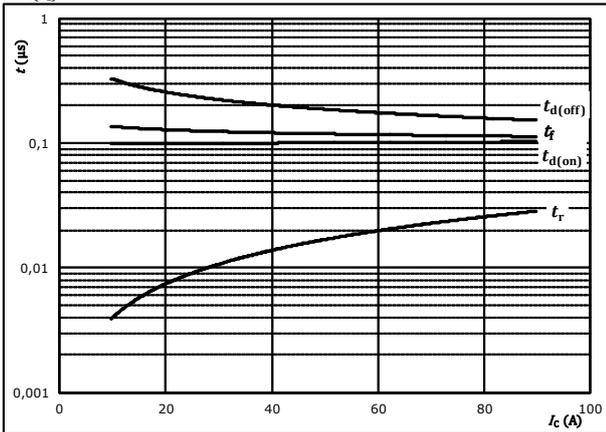


Inverter Switching Characteristics

figure 5. IGBT

Typical switching times as a function of collector current

$$t = f(I_c)$$



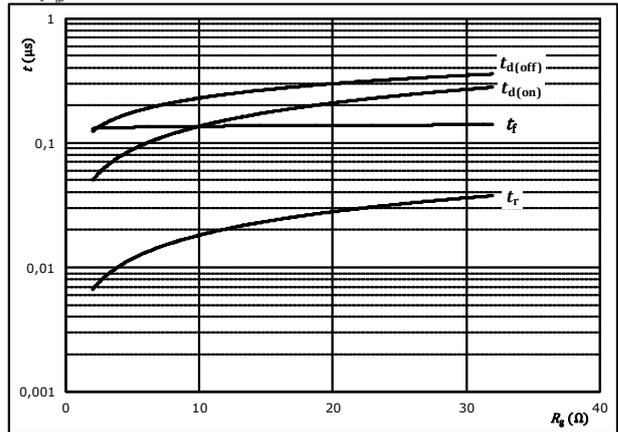
With an inductive load at

$T_j =$	150	°C
$V_{CE} =$	300	V
$V_{GE} =$	±15	V
$R_{g(on)} =$	8	Ω
$R_{g(off)} =$	8	Ω

figure 6. IGBT

Typical switching times as a function of gate resistor

$$t = f(R_g)$$



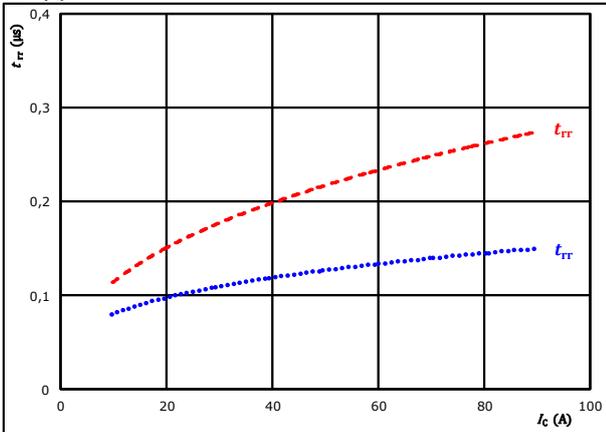
With an inductive load at

$T_j =$	150	°C
$V_{CE} =$	300	V
$V_{GE} =$	±15	V
$I_c =$	50	A

figure 7. FWD

Typical reverse recovery time as a function of collector current

$$t_{rr} = f(I_c)$$

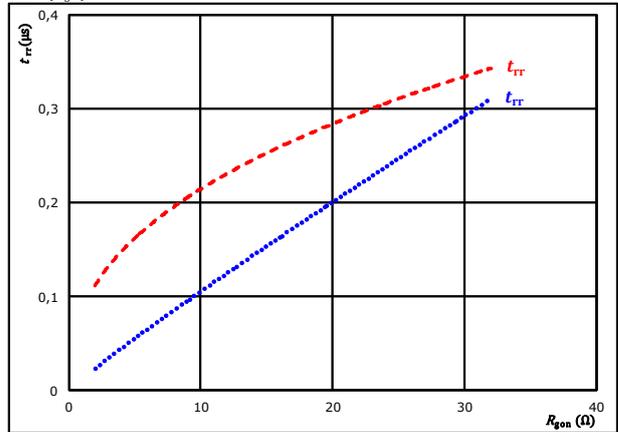


At	$V_{CE} =$	300	V	$T_j =$	25 °C
	$V_{GE} =$	±15	V		150 °C	-----
	$R_{g(on)} =$	8	Ω			

figure 8. FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor

$$t_{rr} = f(R_{g(on)})$$



At	$V_{CE} =$	300	V	$T_j =$	25 °C
	$V_{GE} =$	±15	V		150 °C	-----
	$I_c =$	50	A			



Inverter Switching Characteristics

figure 9. FWD

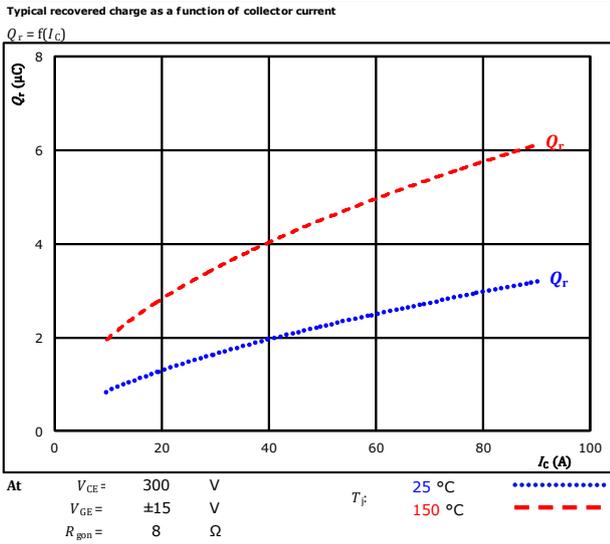


figure 10. FWD

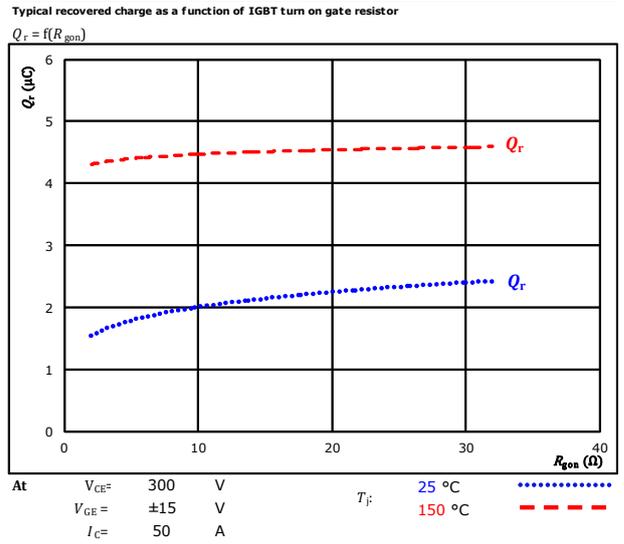


figure 11. FWD

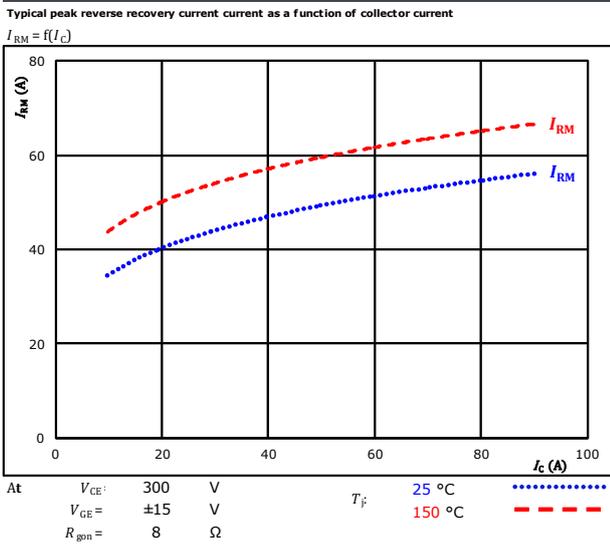
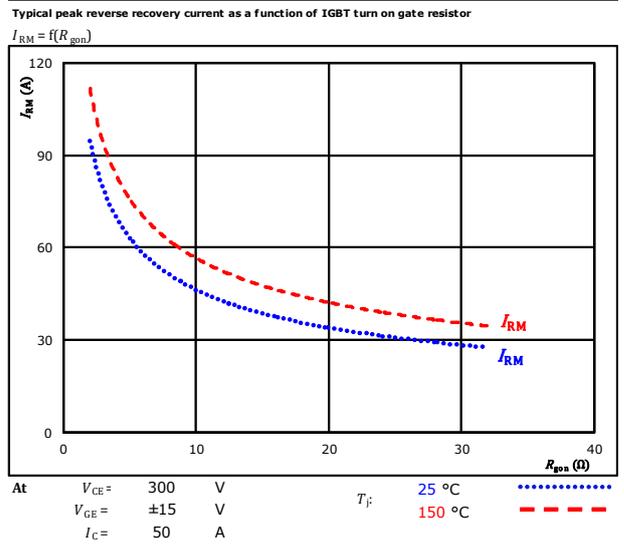


figure 12. FWD

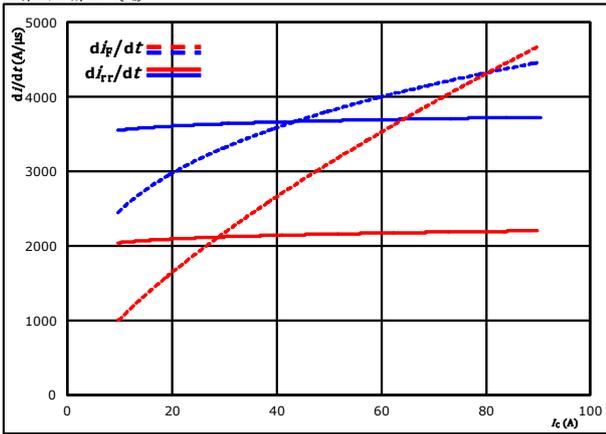




Inverter Switching Characteristics

figure 13. FWD

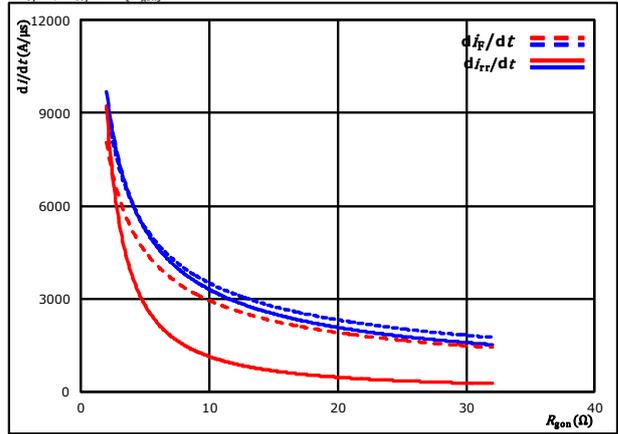
Typical rate of fall of forward and reverse recovery current as a function of collector current
 $di_f/dt, di_{rr}/dt = f(I_c)$



At $V_{CE} = 300$ V $T_j = 25$ °C
 $V_{GE} = \pm 15$ V 150 °C
 $R_{g\text{on}} = 8$ Ω

figure 14. FWD

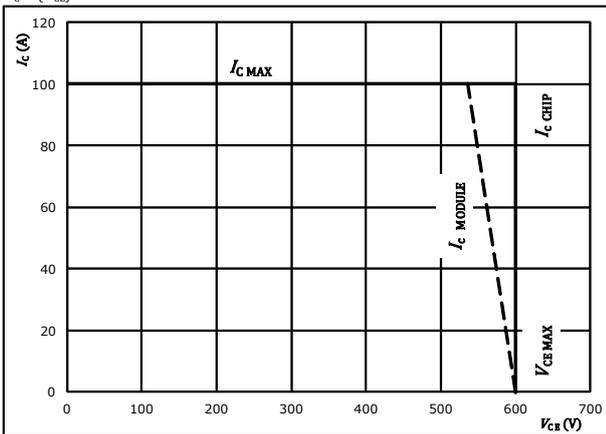
Typical rate of fall of forward and reverse recovery current as a function of IGBT turn on gate resistor
 $di_f/dt, di_{rr}/dt = f(R_{g\text{on}})$



At $V_{CE} = 300$ V $T_j = 25$ °C
 $V_{GE} = \pm 15$ V 150 °C
 $I_c = 50$ A

figure 15. IGBT

Reverse bias safe operating area
 $I_c = f(V_{CE})$



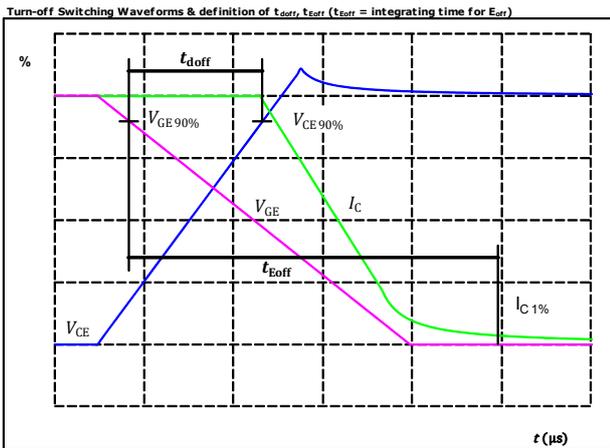
At $T_j = 150$ °C
 $R_{g\text{on}} = 8$ Ω
 $R_{g\text{off}} = 8$ Ω



Inverter Switching Definitions

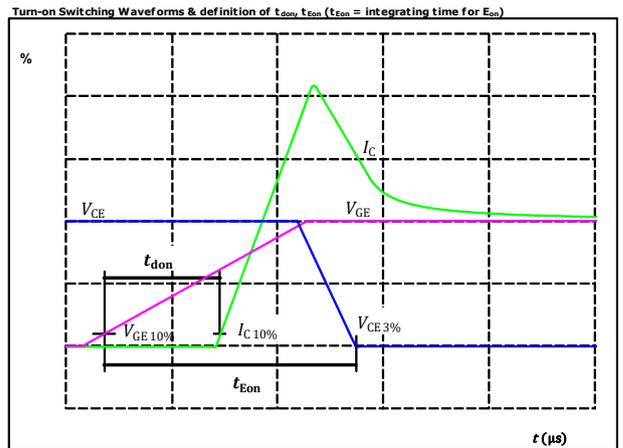
General conditions		
T_j	=	125 °C
R_{gon}	=	8 Ω
R_{goff}	=	8 Ω

figure 1. IGBT



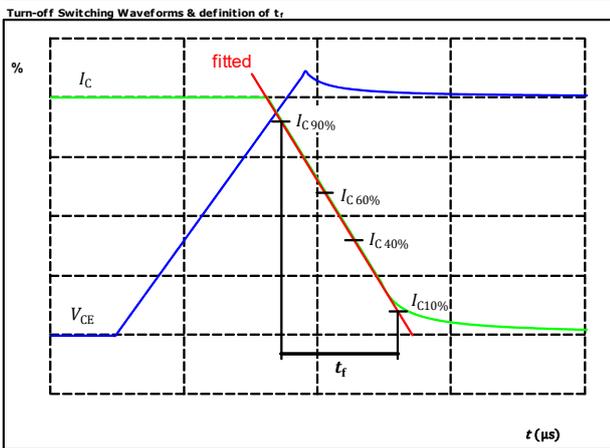
$V_{CE}(0\%) =$	-15	V
$V_{GE}(100\%) =$	15	V
$V_C(100\%) =$	300	V
$I_C(100\%) =$	50	A
$t_{doff} =$	184	ns

figure 2. IGBT



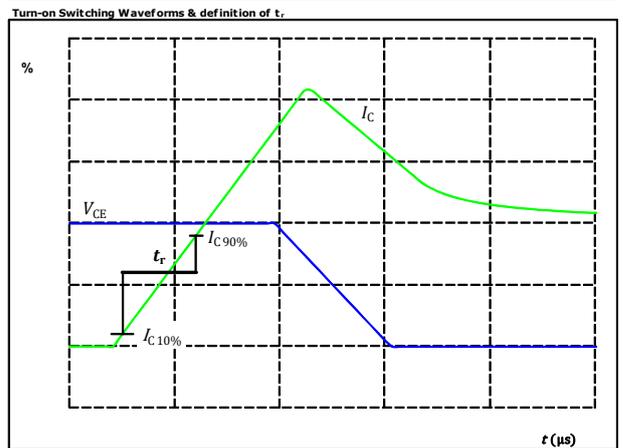
$V_{CE}(0\%) =$	-15	V
$V_{GE}(100\%) =$	15	V
$V_C(100\%) =$	300	V
$I_C(100\%) =$	50	A
$t_{don} =$	100	ns

figure 3. IGBT



$V_C(100\%) =$	300	V
$I_C(100\%) =$	50	A
$t_r =$	131	ns

figure 4. IGBT



$V_C(100\%) =$	300	V
$I_C(100\%) =$	50	A
$t_r =$	18	ns

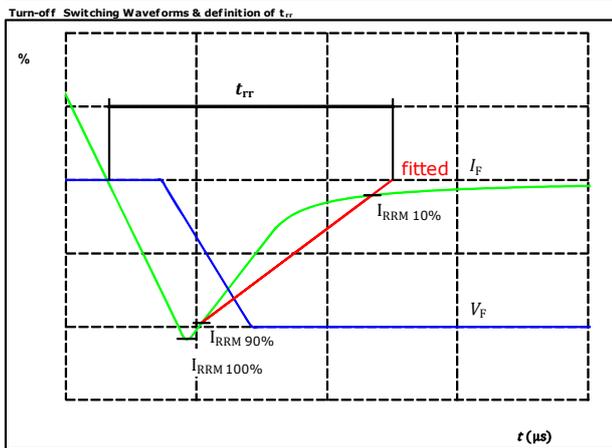


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10-EY06PMA050SA-L184A38T
10-E206PMA050SA-L184A38Z
 datasheet

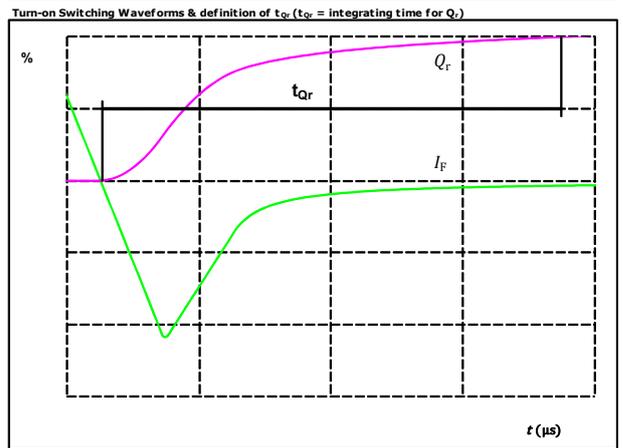
Inverter Switching Characteristics

figure 5. FWD



$V_F(100\%) =$	300	V
$I_F(100\%) =$	50	A
$I_{RRM}(100\%) =$	62	A
$t_{rr} =$	172	ns

figure 6. FWD

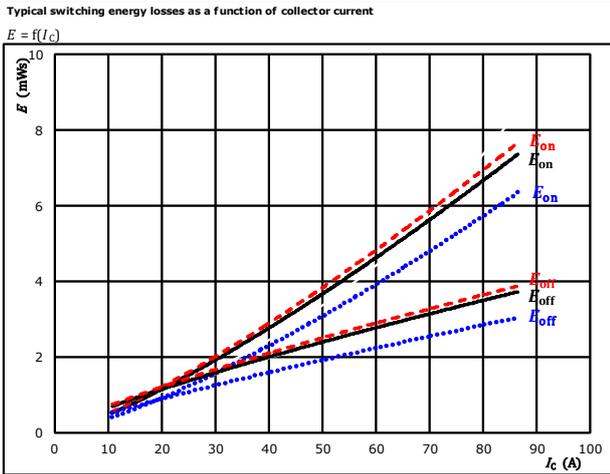


$I_F(100\%) =$	50	A
$Q_r(100\%) =$	4,37	μC



Brake Switching Characteristics

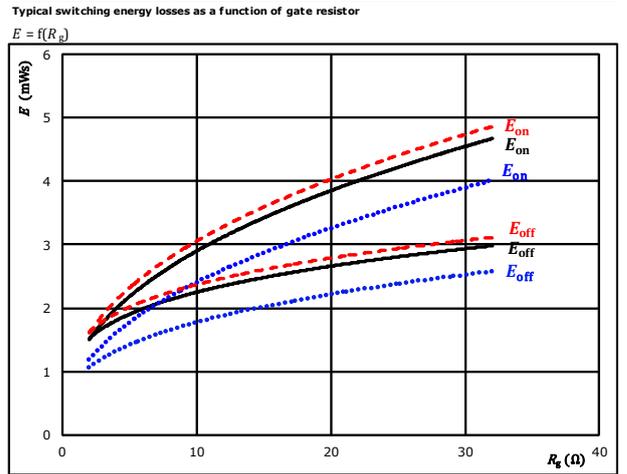
figure 1. IGBT



With an inductive load at
 $V_{CE} = 400$ V
 $V_{GE} = 0 / 15$ V
 $R_{g\text{on}} = 16$ Ω
 $R_{g\text{off}} = 16$ Ω

T_j : 25 °C (dotted blue line)
 125 °C (solid black line)
 150 °C (dashed red line)

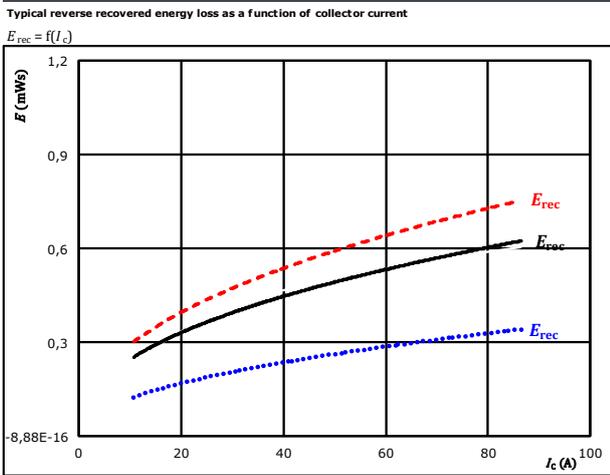
figure 2. IGBT



With an inductive load at
 $V_{CE} = 400$ V
 $V_{GE} = 0 / 15$ V
 $I_C = 50$ A

T_j : 25 °C (dotted blue line)
 125 °C (solid black line)
 150 °C (dashed red line)

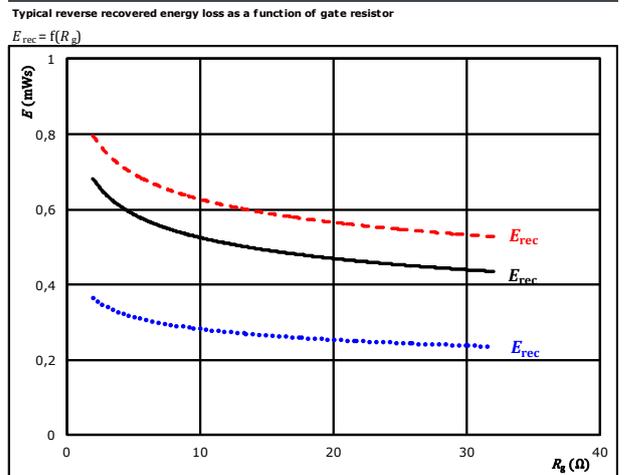
figure 3. FWD



With an inductive load at
 $V_{CE} = 400$ V
 $V_{GE} = 0 / 15$ V
 $R_{g\text{on}} = 16$ Ω

T_j : 25 °C (dotted blue line)
 125 °C (solid black line)
 150 °C (dashed red line)

figure 4. FWD



With an inductive load at
 $V_{CE} = 400$ V
 $V_{GE} = 0 / 15$ V
 $I_C = 50$ A

T_j : 25 °C (dotted blue line)
 125 °C (solid black line)
 150 °C (dashed red line)

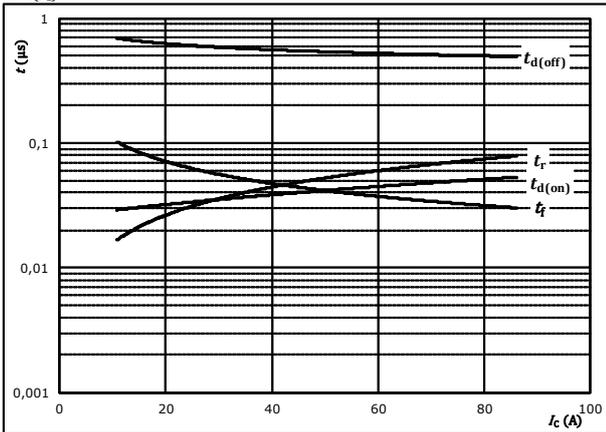


Brake Switching Characteristics

figure 5. IGBT

Typical switching times as a function of collector current

$$t = f(I_C)$$



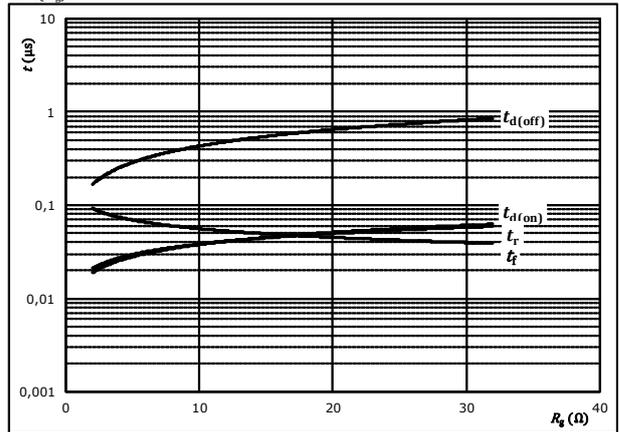
With an inductive load at

$T_j = 150$ °C
 $V_{CE} = 400$ V
 $V_{GE} = 0 / 15$ V
 $R_{g(on)} = 16$ Ω
 $R_{g(off)} = 16$ Ω

figure 6. IGBT

Typical switching times as a function of gate resistor

$$t = f(R_g)$$



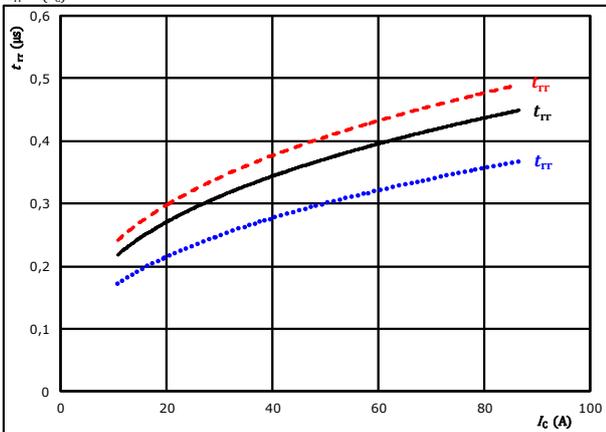
With an inductive load at

$T_j = 150$ °C
 $V_{CE} = 400$ V
 $V_{GE} = 0 / 15$ V
 $I_C = 50$ A

figure 7. FWD

Typical reverse recovery time as a function of collector current

$$t_{rr} = f(I_C)$$

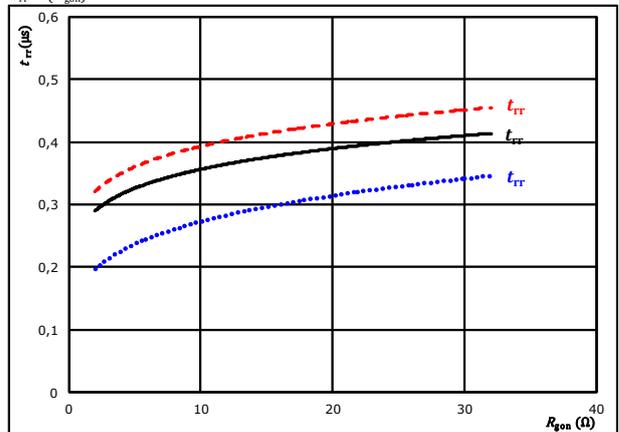


At $V_{CE} = 400$ V
 $V_{GE} = 0 / 15$ V
 $R_{g(on)} = 16$ Ω
 $T_j: 25$ °C (dotted blue)
 125 °C (solid black)
 150 °C (dashed red)

figure 8. FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor

$$t_{rr} = f(R_{g(on)})$$



At $V_{CE} = 400$ V
 $V_{GE} = 0 / 15$ V
 $I_C = 50$ A
 $T_j: 25$ °C (dotted blue)
 125 °C (solid black)
 150 °C (dashed red)

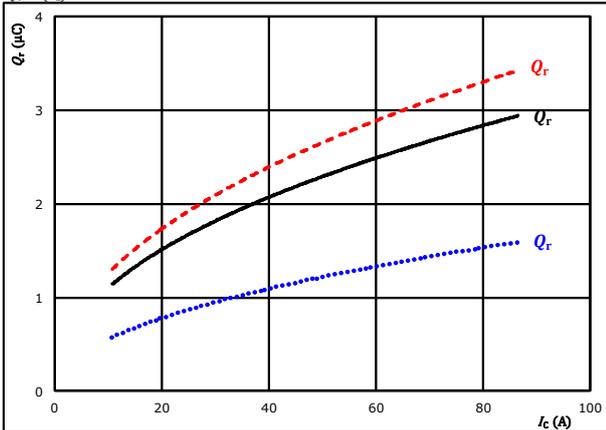


Brake Switching Characteristics

figure 9. FWD

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$

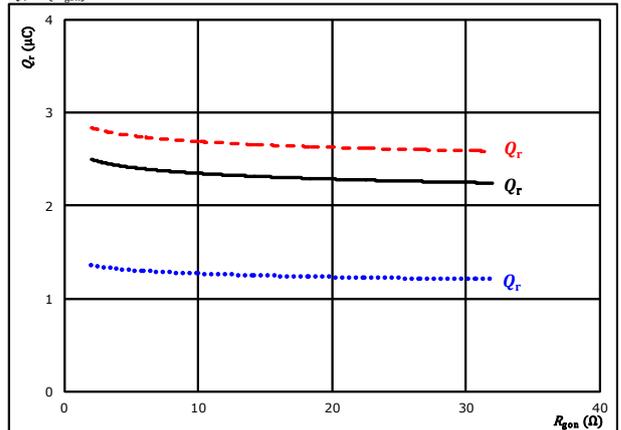


At $V_{CE} = 400$ V $T_j = 25$ °C $V_{GE} = 0 / 15$ V $T_j = 125$ °C $R_{gpn} = 16$ Ω $T_j = 150$ °C

figure 10. FWD

Typical recovered charge as a function of IGBT turn on gate resistor

$$Q_r = f(R_{gpn})$$

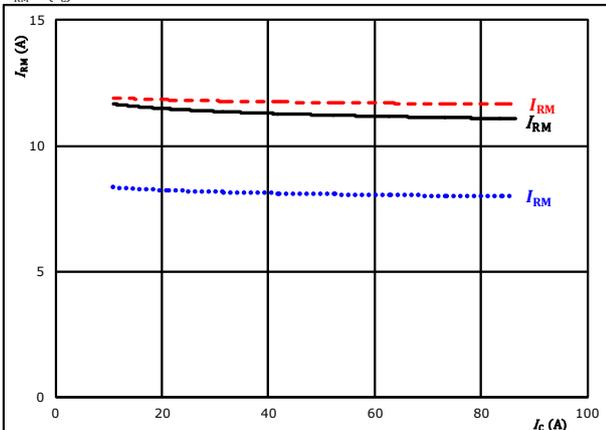


At $V_{CE} = 400$ V $T_j = 25$ °C $V_{GE} = 0 / 15$ V $T_j = 125$ °C $I_c = 50$ A $T_j = 150$ °C

figure 11. FWD

Typical peak reverse recovery current current as a function of collector current

$$I_{RM} = f(I_c)$$

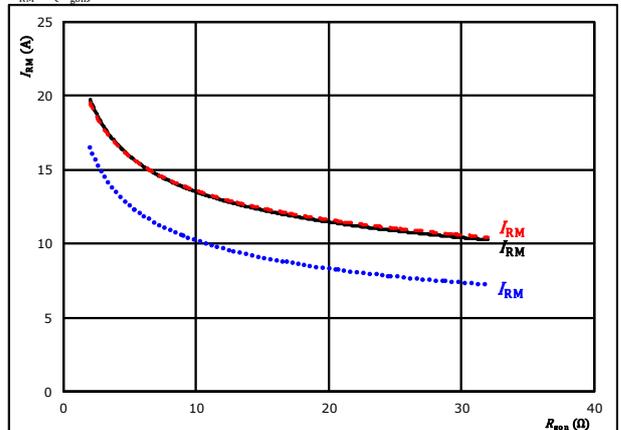


At $V_{CE} = 400$ V $T_j = 25$ °C $V_{GE} = 0 / 15$ V $T_j = 125$ °C $R_{gpn} = 16$ Ω $T_j = 150$ °C

figure 12. FWD

Typical peak reverse recovery current current as a function of IGBT turn on gate resistor

$$I_{RM} = f(R_{gpn})$$



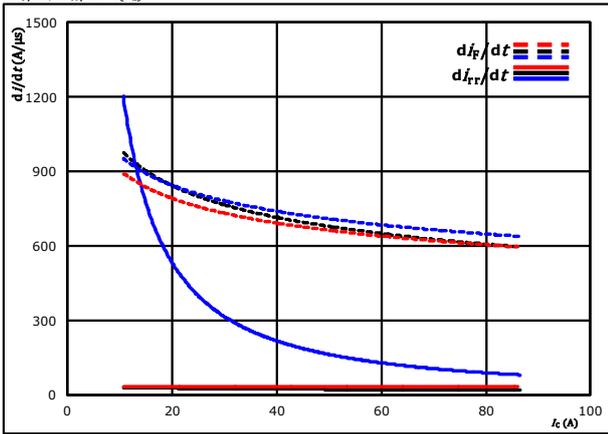
At $V_{CE} = 400$ V $T_j = 25$ °C $V_{GE} = 0 / 15$ V $T_j = 125$ °C $I_c = 50$ A $T_j = 150$ °C



Brake Switching Characteristics

figure 13. FWD

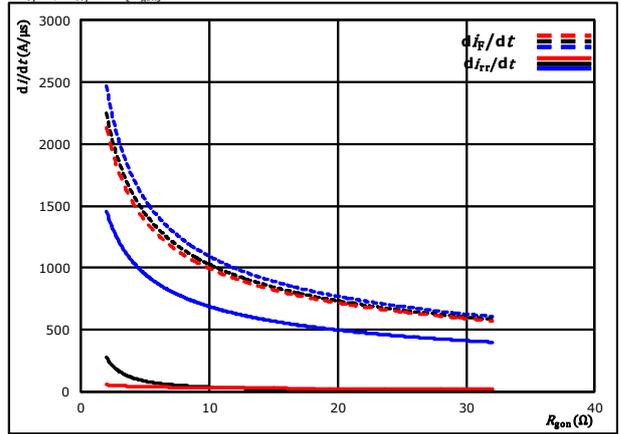
Typical rate of fall of forward and reverse recovery current as a function of collector current
 $di_f/dt, di_{rr}/dt = f(I_c)$



At $V_{CE} = 400$ V $T_j = 25$ °C
 $V_{GE} = 0 / 15$ V $T_j = 125$ °C
 $R_{g(on)} = 16$ Ω $T_j = 150$ °C

figure 14. FWD

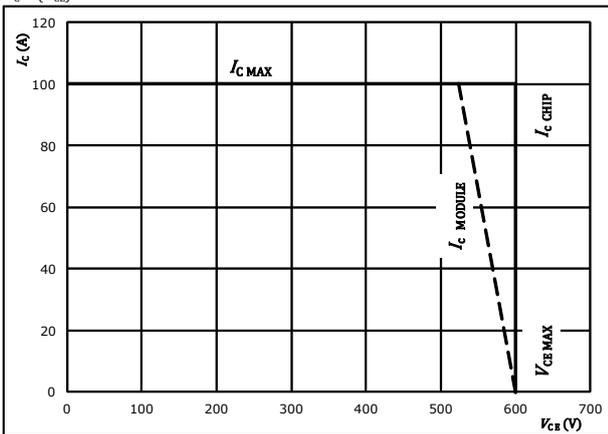
Typical rate of fall of forward and reverse recovery current as a function of IGBT turn on gate resistor
 $di_f/dt, di_{rr}/dt = f(R_{g(on)})$



At $V_{CE} = 400$ V $T_j = 25$ °C
 $V_{GE} = 0 / 15$ V $T_j = 125$ °C
 $I_c = 50$ A $T_j = 150$ °C

figure 15. IGBT

Reverse bias safe operating area
 $I_c = f(V_{CE})$



At $T_j = 125$ °C
 $R_{g(on)} = 16$ Ω
 $R_{g(off)} = 16$ Ω

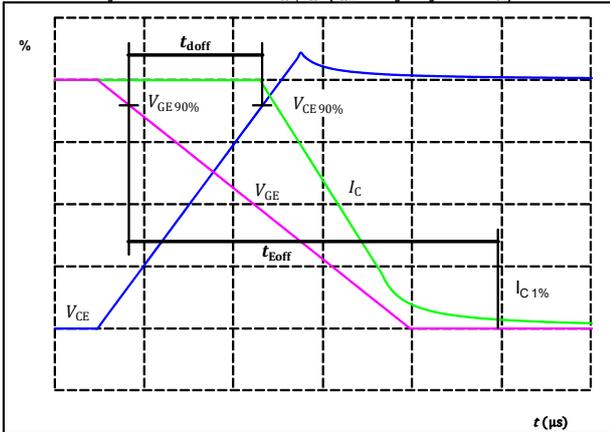


Brake Switching Definitions

General conditions		
T_j	=	125 °C
R_{gon}	=	16 Ω
R_{goff}	=	16 Ω

figure 1. IGBT

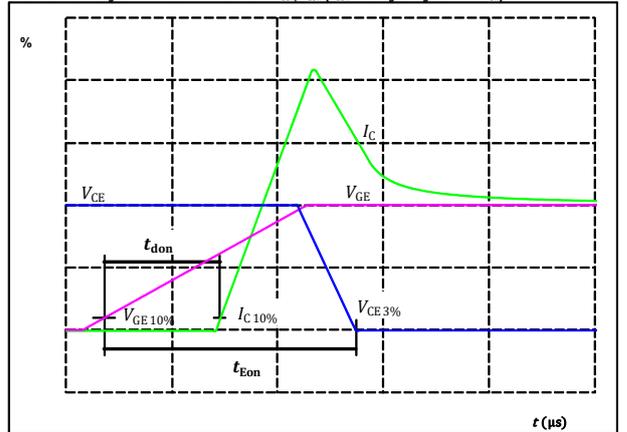
Turn-off Switching Waveforms & definition of t_{doff} , t_{Eoff} (t_{Eoff} = integrating time for E_{off})



$V_{CE}(0\%) =$	0	V
$V_{GE}(100\%) =$	15	V
$V_C(100\%) =$	400	V
$I_C(100\%) =$	50	A
$t_{doff} =$	547	ns

figure 2. IGBT

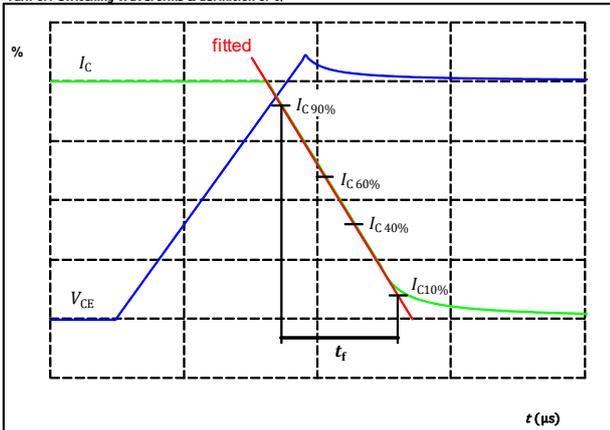
Turn-on Switching Waveforms & definition of t_{don} , t_{Eon} (t_{Eon} = integrating time for E_{on})



$V_{CE}(0\%) =$	0	V
$V_{GE}(100\%) =$	15	V
$V_C(100\%) =$	400	V
$I_C(100\%) =$	50	A
$t_{don} =$	39	ns

figure 3. IGBT

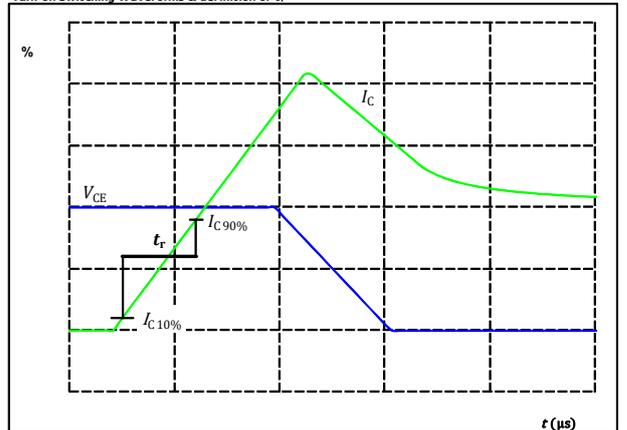
Turn-off Switching Waveforms & definition of t_r



$V_C(100\%) =$	400	V
$I_C(100\%) =$	50	A
$t_r =$	31	ns

figure 4. IGBT

Turn-on Switching Waveforms & definition of t_r



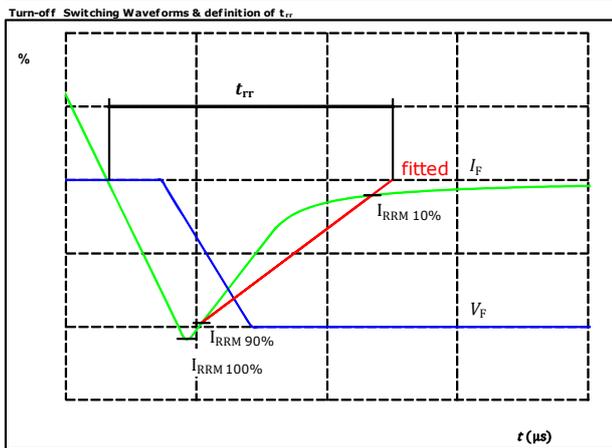
$V_C(100\%) =$	400	V
$I_C(100\%) =$	50	A
$t_r =$	47	ns



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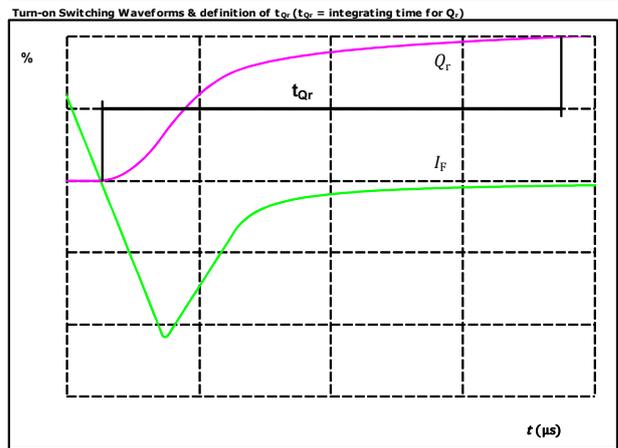
Brake Switching Characteristics

figure 5. FWD



$V_F(100\%) =$	400	V
$I_F(100\%) =$	50	A
$I_{RRM}(100\%) =$	12	A
$t_{rr} =$	360	ns

figure 6. FWD



$I_F(100\%) =$	50	A
$Q_r(100\%) =$	2,28	μC



10-EY06PMA050SA-L184A38T
10-E206PMA050SA-L184A38Z
 datasheet

Vincotech

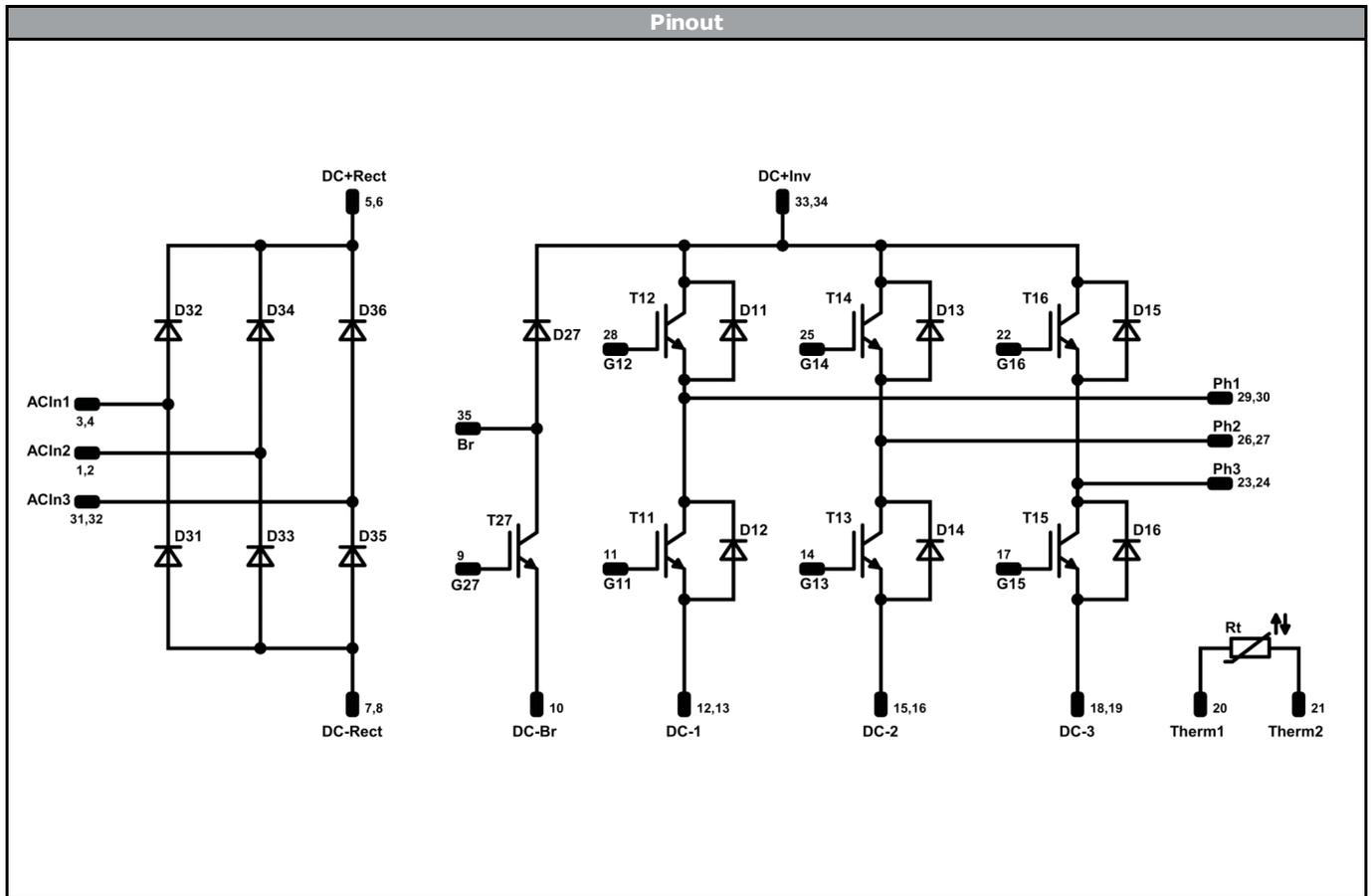
Ordering Code & Marking								
Version			Ordering Code					
without thermal paste 12 mm housing with press-fit pins			10-EY06PMA050SA-L184A38T					
with thermal paste 12 mm housing with press-fit pins			10-EY06PMA050SA-L184A38T-/3/					
without thermal paste 12 mm housing with solder pins			10-E206PMA050SA-L184A38Z					
with thermal paste 12 mm housing with solder pins			10-E206PMA050SA-L184A38Z-/3/					
NN-NNNNNNNNNNNN TTTTIVVWWYY UL VIN LLLL SSSS			Text	Name	Date code	UL & VIN	Lot	Serial
				NN-NNNNNNNNNNNN-TTTTIVV	WWYY	UL VIN	LLLLL	SSSS
			Datamatrix	Type&Ver	Lot number	Serial	Date code	
			TTTTTIVV	LLLLL	SSSS	WWYY		

Pin table				Outline	
Pin	X	Y	Function		
1	25,6	6,4	ACIn2	<p>Solder pin</p> <p>0.64 ±0.03</p> <p>15.9 +0.1 -0.05</p>	
2	22,4	6,4	ACIn2		
3	16	9,6	ACIn1		
4	12,8	9,6	ACIn1		
5	9,6	0	DC+Rect		
6	9,6	3,2	DC+Rect		
7	0	0	DC-Rect		
8	0	3,2	DC-Rect		
9	0	16	G27	<p>Press-fit pin</p> <p>center of press-fit pinhead for connection parameter see the handling instruction</p> <p>13.08 ±0.1 16.4 ±0.05</p>	
10	0	19,2	DC-Br		
11	0	22,4	G11		
12	0	25,6	DC-1		
13	0	28,8	DC-1		
14	0	32	G13		
15	0	35,2	DC-2		
16	0	38,4	DC-2		
17	0	41,6	G15		
18	0	44,8	DC-3		
19	0	48	DC-3		
20	9,6	48	Therm1	<p>24</p> <p>16</p> <p>X</p> <p>Y</p>	
21	19,2	48	Therm2		
22	28,8	48	G16		
23	32	48	Ph3		
24	32	44,8	Ph3		
25	32	35,2	G14		
26	32	32	Ph2		
27	32	28,8	Ph2		
28	32	19,2	G12		
29	32	16	Ph1		
30	32	12,8	Ph1		
31	32	3,2	ACIn3		
32	32	0	ACIn3		
33	22,4	19,2	DC+Inv		
34	22,4	16	DC+Inv		
35	9,6	19,2	Br		

Tolerance of pinpositions: ±0.4mm at the end of pins
 Dimension of coordinate axis is only offset without tolerance



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Identification					
ID	Component	Voltage	Current	Function	Comment
T11, T12, T13, T14, T15, T16	IGBT	600 V	50 A	Inverter Switch	
D11, D12, D13, D14, D15, D16	FWD	600 V	50 A	Inverter Diode	
T27	IGBT	600 V	50 A	Brake Switch	
D27	FWD	600 V	20 A	Brake Diode	
D31, D32, D33, D34, D35, D36	Rectifier	1600 V	45 A	Rectifier Diode	
Rt	NTC			Thermistor	



Packaging instruction			
Standard packaging quantity (SPQ) 100	>SPQ	Standard	<SPQ Sample

Handling instruction
Handling instructions for <i>flow</i> E2 packages see vincotech.com website.

Package data
Package data for <i>flow</i> E2 packages see vincotech.com website.

UL recognition and file number
This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website. 

Document No.:	Date:	Modification:	Pages
10-Ex06PMA050SA-L184A38x-D3-14	30 May. 2019	Correction of I_c/I_f values Outline updated	1,2 27

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.